## PHD13005

# NPN power transistor with integrated diode

Rev. 02 — 29 July 2010

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

High voltage, high speed, planar passivated NPN power switching transistor with integrated anti-parallel E-C diode in a SOT78 plastic package.

#### 1.2 Features and benefits

- Fast switching
- High voltage capability

- Integrated anti-parallel E-C diode
- Low thermal resistance

#### 1.3 Applications

- Integrated fluorescent lamp ballasts e.g. high power cluster lamps
- Low Voltage Tungsten Halogen transformers
- Remote fluorescent lamp ballasts
- Self Oscillating Power Supplies

#### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>C</sub>	collector current	see Figure 1; see Figure 2; see Figure 4; DC	-	-	4	Α
P <sub>tot</sub>	total power dissipation	see <u>Figure 3;</u> T <sub>mb</sub> ≤ 25 °C	-	-	75	W
V <sub>CESM</sub>	collector-emitter peak voltage	V <sub>BE</sub> = 0 V	-	-	700	V
Static char	acteristics					
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V}; I_C = 1.0 \text{ A};$ see Figure 10	12	20	40	
		$V_{CE} = 5 \text{ V}; I_C = 2.0 \text{ A};$ see Figure 10	10	17	28	



#### NPN power transistor with integrated diode

## 2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base		_
2	С	collector	mb	C ↓
3	Е	emitter		в
mb	С	mounting base; connected to collector	1 2 3	E sym131
			SOT78 (TO-220AB)	

## 3. Ordering information

Table 3. Ordering information

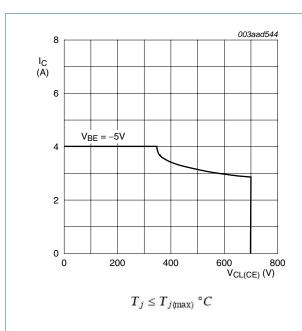
Type number	Package		
	Name	Description	Version
PHD13005	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

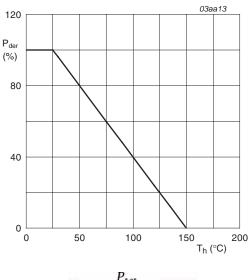
Parameter	Conditions	Min	Max	Unit
collector-emitter peak voltage	$V_{BE} = 0 V$	-	700	V
collector-base voltage	I <sub>E</sub> = 0 A	-	700	V
collector-emitter voltage	$I_B = 0 A$	-	400	V
collector current	DC; see Figure 1; see Figure 2; see Figure 4	-	4	Α
peak collector current	see Figure 4; see Figure 1; see Figure 2	-	8	Α
base current	DC	-	2	Α
peak base current		-	4	Α
total power dissipation	T <sub>mb</sub> ≤ 25 °C; see <u>Figure 3</u>	-	75	W
storage temperature		-65	150	°C
junction temperature		-	150	°C
	collector-emitter peak voltage collector-base voltage collector-emitter voltage collector current peak collector current base current peak base current total power dissipation storage temperature	collector-emitter peak voltage $V_{BE} = 0 \text{ V}$ collector-base voltage $I_E = 0 \text{ A}$ collector-emitter voltage $I_B = 0 \text{ A}$ collector current $DC$ ; see Figure 1; see Figure 2; see Figure 4  peak collector current $DC$ base current $DC$ peak base current  total power dissipation $T_{mb} \le 25 \text{ °C}$ ; see Figure 3  storage temperature	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$



$$\begin{split} V_{\mathit{CL(CE)}} &\leq 1000 \; V; V_{\mathit{CC}} = 150 \; V; V_{\mathit{BB}} = \, -5 \; V; \\ L_{\mathit{B}} &= 1 \, \mu H; L_{\mathit{C}} = 200 \, \mu H \end{split} \label{eq:clce}$$

Fig 1. Reverse bias safe operating area

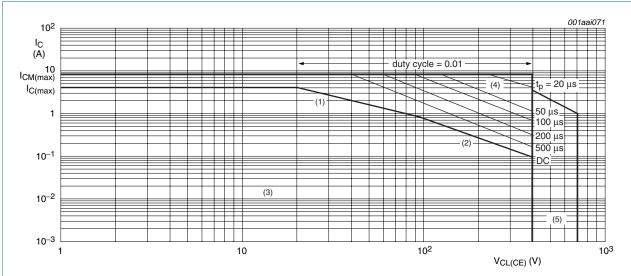
Fig 2. Test circuit for reverse bias safe operating area



 $P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100 \%$ 

Fig 3. Normalized total power dissipation as a function of heatsink temperature

#### NPN power transistor with integrated diode



T<sub>h</sub> ≤ 25 °C

Mounted with heatsink compound and (30  $\pm$  5) N force on the centre of the envelope

- (1)  $P_{tot}$  maximum and  $P_{tot}$  peak maximum lines
- (2) Second breakdown limits
- (3) Region of permissible DC operation
- (4) Extension of operating region for repetitive pulse operation
- (5) Extension of operating region during turn-on in single transistor converters provided that  $R_{BE} \leq 100~\Omega$  and  $t_p \leq 0.6~\mu s$

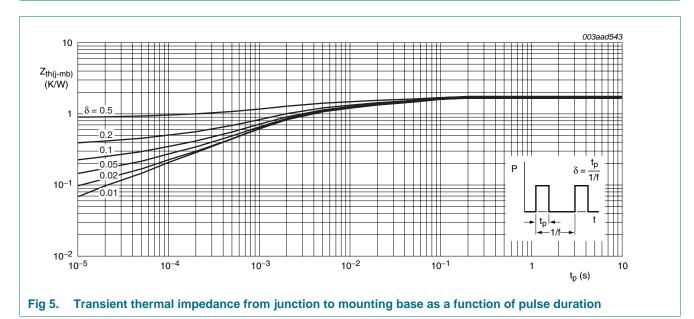
Fig 4. Forward bias safe operating area

#### NPN power transistor with integrated diode

### 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 5	-	-	1.67	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	-	60	-	K/W



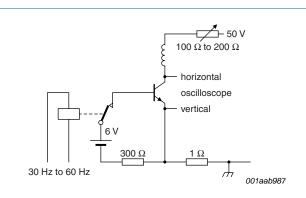
## NPN power transistor with integrated diode

### 6. Characteristics

Table 6 Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
I <sub>CES</sub>	collector-emitter cut-off	$V_{BE} = 0 \text{ V}; V_{CE} = 700 \text{ V}; T_j = 100 ^{\circ}\text{C}$	<u>[1]</u> _	-	5	mΑ
	current	$V_{BE} = 0 \text{ V}; V_{CE} = 700 \text{ V}$	<u>[1]</u> -	-	1	mA
$I_{CBO}$	collector-base cut-off current	$V_{CB} = 700 \text{ V}; I_E = 0 \text{ A}$	<u>[1]</u> -	-	1	mA
I <sub>CEO</sub>	collector-emitter cut-off current	$V_{CE} = 400 \text{ V}; I_B = 0 \text{ A}$	[1] -	-	0.1	mA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 9 \text{ V}; I_{C} = 0 \text{ A}$	-	-	10	mΑ
$V_{CEOsus}$	collector-emitter sustaining voltage	$I_B = 0 \text{ A}$ ; $I_C = 10 \text{ mA}$ ; $L_C = 25 \text{ mH}$ ; see Figure 6; see Figure 15	400	-	-	V
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 1.0 \text{ A}$ ; $I_B = 0.2 \text{ A}$ ; see Figure 7; see Figure 8	-	0.1	0.5	V
		$I_C = 2.0 \text{ A}$ ; $I_B = 0.5 \text{ A}$ ; see Figure 7; see Figure 8	-	0.2	0.6	V
		$I_C = 4.0 \text{ A}$ ; $I_B = 1.0 \text{ A}$ ; see Figure 7; see Figure 8	-	0.3	1	V
$V_{BEsat}$	base-emitter saturation	$I_C = 2.0 \text{ A}$ ; $I_B = 0.5 \text{ A}$ ; see <u>Figure 9</u>	-	0.92	1.6	V
voltage		$I_C = 1.0 \text{ A}$ ; $I_B = 0.2 \text{ A}$ ; see <u>Figure 9</u>	-	0.85	1.2	V
$V_{F}$	forward voltage	I <sub>F</sub> = 2.0 A	-	1.04	1.5	V
h <sub>FE</sub>	DC current gain	$I_C = 1.0 \text{ A}; V_{CE} = 5 \text{ V}; \text{ see } \frac{\text{Figure 10}}{}$	12	20	40	
		$I_C = 2.0 \text{ A}$ ; $V_{CE} = 5 \text{ V}$ ; see <u>Figure 10</u>	10	17	28	
Dynamic	characteristics					
t <sub>s</sub>	storage time	$I_C$ = 2.0 A; $I_{Bon}$ = 0.4 A; $V_{BB}$ = -5 V; $L_B$ = 1 $\mu$ H; inductive load; see <u>Figure 11</u> ; see <u>Figure 12</u>	-	1.2	2	μs
		$I_C$ = 2.0 A; $I_{Bon}$ = 0.4 A; $I_{Boff}$ = -0.4 A; $R_L$ = 75 Ω; resistive load; see Figure 13; see Figure 14	-	2.7	4	μs
		$I_C$ = 2.0 A; $I_{Bon}$ = 0.4 A; $V_{BB}$ = -5 V; $L_B$ = 1 $\mu$ H; $T_j$ = 100 °C; inductive load; see Figure 11; see Figure 12	-	1.4	4	μs
t <sub>f</sub>	fall time	$I_C$ = 2.0 A; $I_{Bon}$ = 0.4 A; $I_{Boff}$ = -0.4 A; $R_L$ = 75 $\Omega$ ; resistive load; see <u>Figure 13</u> ; see <u>Figure 14</u>	-	0.3	0.9	μs
		$I_C$ = 2.0 A; $I_{Bon}$ = 0.4 A; $V_{BB}$ = -5 V; $L_B$ = 1 $\mu$ H; $T_j$ = 100 °C; inductive load; see <u>Figure 11</u> ; see <u>Figure 12</u>	-	0.16	0.9	μs
		$I_C$ = 2.0 A; $I_{Bon}$ = 0.4 A; $V_{BB}$ = -5 V; $L_B$ = 1 $\mu$ H; inductive load; see <u>Figure 11</u> ; see <u>Figure 12</u>	-	0.1	0.5	μs

<sup>[1]</sup> measured with half-sine wave voltage (curve tracer)



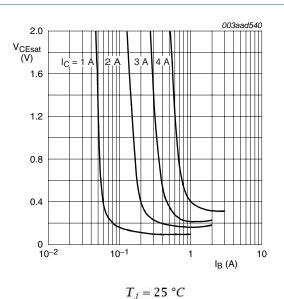
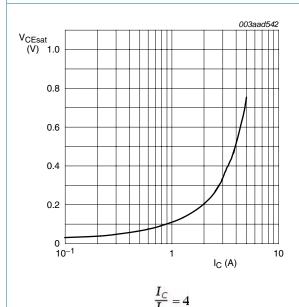


Fig 6. Test circuit for collector-emitter sustaining voltage

Fig 7. Collector-emitter saturation voltage; typical values





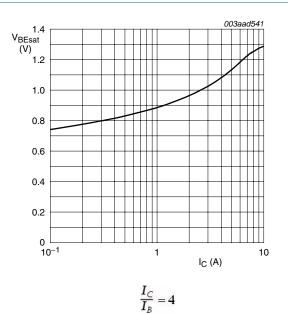


Fig 9. Base-emitter saturation voltage; typical values

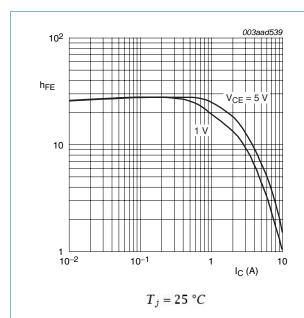
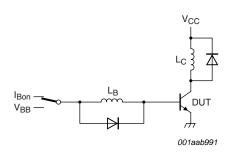


Fig 10. DC current gain as a function of collector current; typical values



$$V_{CC} = 300 \ V; V_{BB} = -5 \ V; L_C = 200 \ \mu H; L_B = 1 \ \mu H$$

Fig 11. Test circuit for inductive load switching

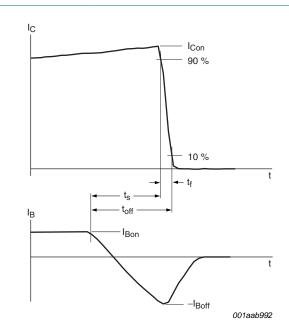
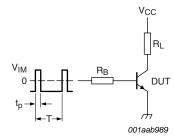
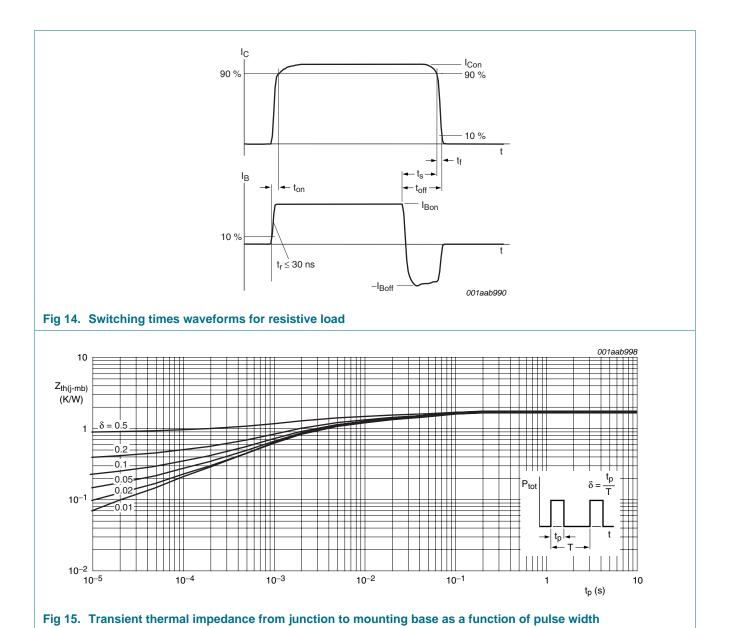


Fig 12. Switching times waveforms for inductive load



$$V_{IM}=-6$$
 to  $+8$   $V$ ;  $V_{CC}=250$   $V$ ;  $t_p=20$   $\mu s$ ;  $\pmb{\delta}=\frac{t_p}{T}=0.01$   $R_B$  and  $R_L$  calculated from  $I_{Con}$  and  $I_{Bon}$  requirements.

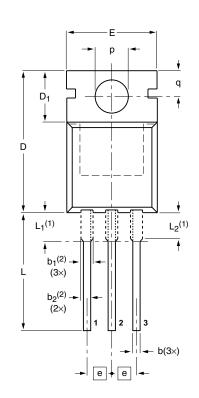
Fig 13. Test circuit for resistive load switching

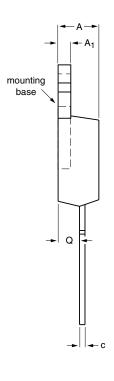


#### NPN power transistor with integrated diode

## 7. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB SOT78





0 5 10 mm

#### **DIMENSIONS (mm are the original dimensions)**

UNIT	А	A <sub>1</sub>	b	b <sub>1</sub> (2)	b <sub>2</sub> <sup>(2)</sup>	С	D	D <sub>1</sub>	E	е	L	L <sub>1</sub> (1)	L <sub>2</sub> <sup>(1)</sup> max.	р	q	Q
mm	4.7 4.1	1.40 1.25	0.9 0.6	1.6 1.0	1.3 1.0	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2

#### Notes

- 1. Lead shoulder designs may vary.
- 2. Dimension includes excess dambar.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT78		3-lead TO-220AB	SC-46			<del>08-04-23</del> 08-06-13	

Fig 16. Package outline SOT78 (TO-220AB)

PHD13005

### NPN power transistor with integrated diode

## 8. Revision history

#### Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PHD13005 v.2	20100729	Product data sheet	-	PHD13005 v.1
Modifications:	<ul> <li>Various chang</li> </ul>			
PHD13005 v.1	20100520	Product data sheet	-	-

#### NPN power transistor with integrated diode

### 9. Legal information

#### 9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

#### 9.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### 9.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on a weakness or default in the customer application/use or the application/use of customer's third party customer(s) (hereinafter both referred to as "Application"). It is customer's sole responsibility to check whether the NXP Semiconductors product is suitable and fit for the Application planned. Customer has to do all necessary testing for the Application in order to avoid a default of the Application and the product. NXP Semiconductors does not accept any liability in this respect.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding. Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

PHD13005

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2010. All rights reserved.

#### NPN power transistor with integrated diode

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

#### 9.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

Adelante, Bitport, Bitsound, CoolFlux, CoReUse, DESFire, EZ-HV, FabKey, GreenChip, HiPerSmart, HITAG, I²C-bus logo, ICODE, I-CODE, ITEC, Labelution, MIFARE, MIFARE Plus, MIFARE Ultralight, MoReUse, QLPAK, Silicon Tuner, SiliconMAX, SmartXA, STARplug, TOPFET, TrenchMOS, TriMedia and UCODE — are trademarks of NXP B.V.

**HD Radio** and **HD Radio** logo — are trademarks of iBiquity Digital Corporation.

#### 10. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

PHD13005 **NXP Semiconductors** 

#### NPN power transistor with integrated diode

## 11. Contents

1	Product profile
1.1	General description
1.2	Features and benefits1
1.3	Applications
1.4	Quick reference data1
2	Pinning information
3	Ordering information
4	Limiting values
5	Thermal characteristics5
6	Characteristics6
7	Package outline
8	Revision history11
9	Legal information12
9.1	Data sheet status
9.2	Definitions12
9.3	Disclaimers
9.4	Trademarks13
10	Contact information

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

## **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

NXP:

PHD13005,127